

#### VOLTAGE RANGE: 50Volts TO 1000Volts CURRENT: 1.0 Ampere

### **Features**

- \* The plastic material used carries Underwriters Laboratory flammability recognition 94V-0
- \* Surge overload ratings to 30 amperes
- \* Ideal for Printed Circuit Board Application
- \* High temperature soldering guaranteed
  265'C/10 seconds at 5 lbs (2.3kg) tension

### **Mechanical Data**

- \* Case: Molded plastic: ABS
- Terminals: Plated leads solderable per MIL-STD-202, method 208
- \* Polarity: Polarity symbols molded on body
- \* Mounting position: Any
- \* Weight: 0.12 grams(approx)



## **Maximum Ratings and Electrical Characteristics**

Rating 25'C ambient temperature unless otherwies specified, Resistive or Inductive load, 60Hz. For capacitive load derate current by 20%.

TYPE NUMBER			ABS05	ABS1	ABS2	ABS4	ABS6	ABS8	ABS10	units
Maximum Repetitive Peak Reverse Voltage		VRRM	50	100	200	400	600	800	1000	v
Maximum RMS Bridge Input Voltage		VRMS	35	70	140	280	420	560	700	v
Maximum DC Blocking Voltage		VDC	50	100	200	400	600	800	1000	v
Maximum Average Forward Rectified Output Current TA=40'C <sup>note 3</sup>		IF(AV)	1.0							Α
Peak Forward Surge Current single half sine-wave superimposed on rated load (JEDEC method)		Ігѕм		30						
Maximum Instantaneous Forward Voltage drop per leg at 0.4A		VF		1.0						
Maximum DC Reverse Current at Rate DC Blocking Voltage per element	TJ=25'C	IR	5.0							uA
	TJ=125'C		500							
Rating for fusing ( t<8.3ms)		l <sup>2</sup> t	10							A <sup>2</sup> sec
Typical Thermal Resistance per element Note1		Reja	75							'C/W
Typical Junction capacitance per element Note2		Cj	25.0							pF
Operating and Storage Temperature Range		Тյ, Tsтg	- 55 ~ + 150							'C

Note: 1.thermal resistance from junction to Ambemt on P.C. Board mounting

2. Measured at 2.0MHz and applied reverse voltage of 4.0 volts.

3. R-load on aluminum substrate T<sub>A</sub>=25'C.

# Typical Characteristics (TJ = 25'C unless otherwise noted )

